



SCCS067A - July 1994 - Revised October 2001

# CY74FCT16841T CY74FCT162841T

## 20-Bit Latches

### Features

- FCT-C speed at 5.5 ns (FCT16841T Com'I)
- $I_{off}$  supports partial-power-down mode operation
- Edge-rate control circuitry for significantly improved noise characteristics
- Typical output skew < 250 ps
- ESD > 2000V
- TSSOP (19.6-mil pitch) and SSOP (25-mil pitch) packages
- Industrial temperature range of  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$
- $V_{CC} = 5V \pm 10\%$

#### CY74FCT16841T Features:

- 64 mA sink current, 32 mA source current
- Typical  $V_{OLP}$  (ground bounce) < 1.0V at  $V_{CC} = 5V$ ,  $T_A = 25^{\circ}\text{C}$

#### CY74FCT162841T Features:

- Balanced 24 mA output drivers
- Reduced system switching noise
- Typical  $V_{OLP}$  (ground bounce) < 0.6V at  $V_{CC} = 5V$ ,  $T_A = 25^{\circ}\text{C}$

### Functional Description

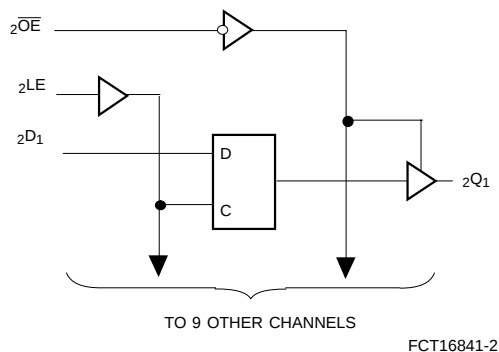
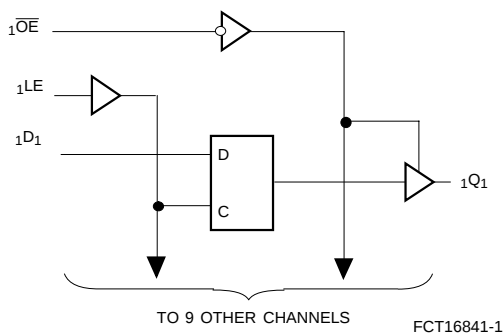
The CY74FCT16841T and CY74FCT162841T are 20-bit D-type latches designed for use in bus applications requiring high speed and low power. These devices can be used as two independent 10-bit latches, or as a single 10-bit latch, or as a single 20-bit latch by connecting the Output Enable ( $\overline{OE}$ ) and Latch (LE) inputs. Flow-through pinout and small shrink packaging aid in simplifying board layout.

This device is fully specified for partial-power-down applications using  $I_{off}$ . The  $I_{off}$  circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

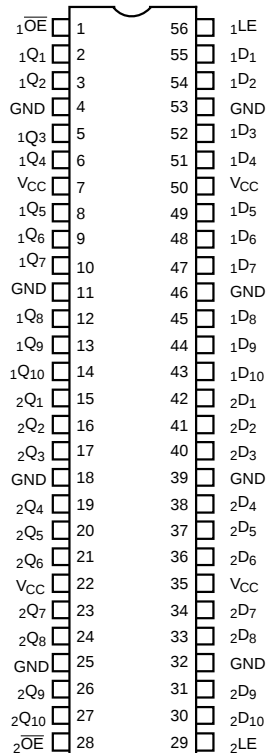
The CY74FCT16841T is ideally suited for driving high-capacitance loads and low-impedance backplanes.

The CY74FCT162841T has 24-mA balanced output drivers with current limiting resistors in the outputs. This reduces the need for external terminating resistors and provides for minimal undershoot and reduced ground bounce. The CY74FCT162841T is ideal for driving transmission lines.

### Logic Block Diagrams



### Pin Configuration SSOP/TSSOP Top View



FCT16841-3

## Pin Description

| Name            | Description                      |
|-----------------|----------------------------------|
| D               | Data Inputs                      |
| LE              | Latch Enable Input (Active HIGH) |
| $\overline{OE}$ | Output Enable Input (Active LOW) |
| O               | Three-State Outputs              |

## Function Table<sup>[1]</sup>

| Inputs |    |                 | Outputs          |
|--------|----|-----------------|------------------|
| D      | LE | $\overline{OE}$ | Q                |
| H      | H  | L               | H                |
| L      | H  | L               | L                |
| X      | L  | L               | Q <sup>[2]</sup> |
| X      | X  | H               | Z                |

## Maximum Ratings<sup>[3, 4]</sup>

(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature ..... -55°C to +125°C

Ambient Temperature with

Power Applied ..... -55°C to +125°C

DC Input Voltage ..... -0.5V to +7.0V

DC Output Voltage ..... -0.5V to +7.0V

DC Output Current

(Maximum Sink Current/Pin) ..... -60 to +120 mA

Power Dissipation ..... 1.0W

Static Discharge Voltage ..... >2001V  
(per MIL-STD-883, Method 3015)

## Operating Range

| Range      | Ambient Temperature | V <sub>CC</sub> |
|------------|---------------------|-----------------|
| Industrial | -40°C to +85°C      | 5V ± 10%        |

## Electrical Characteristics Over the Operating Range

| Parameter        | Description                                             | Test Conditions                                            | Min. | Typ. <sup>[5]</sup> | Max. | Unit |
|------------------|---------------------------------------------------------|------------------------------------------------------------|------|---------------------|------|------|
| V <sub>IH</sub>  | Input HIGH Voltage                                      | Logic HIGH Level                                           | 2.0  |                     |      | V    |
| V <sub>IL</sub>  | Input LOW Voltage                                       | Logic LOW Level                                            |      |                     | 0.8  | V    |
| V <sub>H</sub>   | Input Hysteresis <sup>[6]</sup>                         |                                                            |      | 100                 |      | mV   |
| V <sub>IK</sub>  | Input Clamp Diode Voltage                               | V <sub>CC</sub> =Min., I <sub>IN</sub> =-18 mA             |      | -0.7                | -1.2 | V    |
| I <sub>IH</sub>  | Input HIGH Current                                      | V <sub>CC</sub> =Max., V <sub>I</sub> =V <sub>CC</sub>     |      |                     | ±1   | µA   |
| I <sub>IL</sub>  | Input LOW Current                                       | V <sub>CC</sub> =Max., V <sub>I</sub> =GND                 |      |                     | ±1   | µA   |
| I <sub>OZH</sub> | High Impedance Output Current (Three-State Output pins) | V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.7V              |      |                     | ±1   | µA   |
| I <sub>OZL</sub> | High Impedance Output Current (Three-State Output pins) | V <sub>CC</sub> =Max., V <sub>OUT</sub> =0.5V              |      |                     | ±1   | µA   |
| I <sub>OS</sub>  | Short Circuit Current <sup>[7]</sup>                    | V <sub>CC</sub> =Max., V <sub>OUT</sub> =GND               | -80  | -140                | -200 | mA   |
| I <sub>O</sub>   | Output Drive Current <sup>[7]</sup>                     | V <sub>CC</sub> =Max., V <sub>OUT</sub> =2.5V              | -50  |                     | -180 | mA   |
| I <sub>OFF</sub> | Power-Off Disable                                       | V <sub>CC</sub> =0V, V <sub>OUT</sub> ≤4.5V <sup>[8]</sup> |      |                     | ±1   | µA   |

### Notes:

1. H = HIGH Voltage Level. L = LOW Voltage Level. X = Don't Care. Z = HIGH Impedance.
2. Output level before LE HIGH-to-LOW Transition.
3. Operation beyond the limits set forth may impair the useful life of the device. Unless otherwise noted, these limits are over the operating free-air temperature range.
4. Unused inputs must always be connected to an appropriate logic voltage level, preferably either V<sub>CC</sub> or ground.
5. Typical values are at V<sub>CC</sub>= 5.0V, T<sub>A</sub>= +25°C ambient.
6. This parameter is specified but not tested.
7. Not more than one output should be shorted at a time. Duration of short should not exceed one second. The use of high-speed test apparatus and/or sample and hold techniques are preferable in order to minimize internal chip heating and more accurately reflect operational values. Otherwise prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parametric tests. In any sequence of parameter tests, I<sub>OS</sub> tests should be performed last.
8. Tested at +25°C.

**Output Drive Characteristics for CY74FCT16841T**

| Parameter       | Description         | Test Conditions                                | Min. | Typ. <sup>[5]</sup> | Max. | Unit |
|-----------------|---------------------|------------------------------------------------|------|---------------------|------|------|
| V <sub>OH</sub> | Output HIGH Voltage | V <sub>CC</sub> =Min., I <sub>OH</sub> =-3 mA  | 2.5  | 3.5                 |      | V    |
|                 |                     | V <sub>CC</sub> =Min., I <sub>OH</sub> =-15 mA | 2.4  | 3.5                 |      |      |
|                 |                     | V <sub>CC</sub> =Min., I <sub>OH</sub> =-32 mA | 2.0  | 3.0                 |      |      |
| V <sub>OL</sub> | Output LOW Voltage  | V <sub>CC</sub> =Min., I <sub>OL</sub> =64 mA  |      | 0.2                 | 0.55 | V    |

**Output Drive Characteristics for CY74FCT162841T**

| Parameter        | Description                        | Test Conditions                                                                                   | Min. | Typ. <sup>[5]</sup> | Max. | Unit |
|------------------|------------------------------------|---------------------------------------------------------------------------------------------------|------|---------------------|------|------|
| I <sub>ODL</sub> | Output LOW Current <sup>[7]</sup>  | V <sub>CC</sub> =5V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V | 60   | 115                 | 150  | mA   |
| I <sub>ODH</sub> | Output HIGH Current <sup>[7]</sup> | V <sub>CC</sub> =5V, V <sub>IN</sub> =V <sub>IH</sub> or V <sub>IL</sub> , V <sub>OUT</sub> =1.5V | -60  | -115                | -150 | mA   |
| V <sub>OH</sub>  | Output HIGH Voltage                | V <sub>CC</sub> =Min., I <sub>OH</sub> =-24 mA                                                    | 2.4  | 3.3                 |      | V    |
| V <sub>OL</sub>  | Output LOW Voltage                 | V <sub>CC</sub> =Min., I <sub>OL</sub> =24 mA                                                     |      | 0.3                 | 0.55 | V    |

**Capacitance<sup>[6]</sup> (T<sub>A</sub> = +25°C, f = 1.0 MHz)**

| Symbol           | Description        | Conditions            | Typ. <sup>[5]</sup> | Max. | Unit |
|------------------|--------------------|-----------------------|---------------------|------|------|
| C <sub>IN</sub>  | Input Capacitance  | V <sub>IN</sub> = 0V  | 4.5                 | 6.0  | pF   |
| C <sub>OUT</sub> | Output Capacitance | V <sub>OUT</sub> = 0V | 5.5                 | 8.0  | pF   |

**Power Supply Characteristics**

| Parameter        | Description                                      | Test Conditions                                                                                                                                         |                                                                 | Min. | Typ. <sup>[5]</sup> | Max.                 | Unit   |
|------------------|--------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|-----------------------------------------------------------------|------|---------------------|----------------------|--------|
| I <sub>CC</sub>  | Quiescent Power Supply Current                   | V <sub>CC</sub> =Max.                                                                                                                                   | V <sub>IN</sub> ≤0.2V<br>V <sub>IN</sub> ≥V <sub>CC</sub> -0.2V | —    | 5                   | 500                  | μA     |
| ΔI <sub>CC</sub> | Quiescent Power Supply Current (TTL inputs HIGH) | V <sub>CC</sub> =Max.,                                                                                                                                  | V <sub>IN</sub> =3.4V <sup>[9]</sup>                            | —    | 0.5                 | 1.5                  | mA     |
| I <sub>CCD</sub> | Dynamic Power Supply Current <sup>[10]</sup>     | V <sub>CC</sub> =Max., One Input Toggling, 50% Duty Cycle, Outputs Open, $\overline{\text{OE}}$ =GND                                                    | V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND        | —    | 60                  | 100                  | μA/MHz |
| I <sub>C</sub>   | Total Power Supply Current <sup>[11]</sup>       | V <sub>CC</sub> =Max., f <sub>1</sub> =10 MHz, 50% Duty Cycle, Outputs Open, One Bit Toggling, $\overline{\text{OE}}$ =GND<br>LE = V <sub>CC</sub>      | V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND        | —    | 0.6                 | 1.5                  | mA     |
|                  |                                                  |                                                                                                                                                         | V <sub>IN</sub> =3.4V or V <sub>IN</sub> =GND                   | —    | 0.9                 | 2.3                  |        |
|                  |                                                  | V <sub>CC</sub> =Max., f <sub>1</sub> =2.5 MHz, 50% Duty Cycle, Outputs Open, Twenty Bits Toggling, $\overline{\text{OE}}$ =GND<br>LE = V <sub>CC</sub> | V <sub>IN</sub> =V <sub>CC</sub> or V <sub>IN</sub> =GND        | —    | 3.0                 | 5.5 <sup>[12]</sup>  |        |
|                  |                                                  |                                                                                                                                                         | V <sub>IN</sub> =3.4V or V <sub>IN</sub> =GND                   | —    | 8.0                 | 20.5 <sup>[12]</sup> |        |

**Notes:**

9. Per TTL driven input (V<sub>IN</sub>=3.4V); all other inputs at V<sub>CC</sub> or GND.
10. This parameter is not directly testable, but is derived for use in Total Power Supply calculations.
11. I<sub>C</sub> = I<sub>QUIESCENT</sub> + I<sub>INPUTS</sub> + I<sub>DYNAMIC</sub>  
I<sub>C</sub> = I<sub>CC</sub> + ΔI<sub>CC</sub>D<sub>H</sub>N<sub>T</sub> + I<sub>CCD</sub>(f<sub>0</sub>/2 + f<sub>1</sub>N<sub>1</sub>)  
I<sub>CC</sub> = Quiescent Current with CMOS input levels  
ΔI<sub>CC</sub> = Power Supply Current for a TTL HIGH input (V<sub>IN</sub>=3.4V)  
D<sub>H</sub> = Duty Cycle for TTL inputs HIGH  
N<sub>T</sub> = Number of TTL inputs at D<sub>H</sub>  
I<sub>CCD</sub> = Dynamic Current caused by an input transition pair (HLH or LHL)  
f<sub>0</sub> = Clock frequency for registered devices, otherwise zero  
f<sub>1</sub> = Input signal frequency  
N<sub>1</sub> = Number of inputs changing at f<sub>1</sub>  
All currents are in milliamps and all frequencies are in megahertz.
12. Values for these conditions are examples of the I<sub>CC</sub> formula. These limits are specified but not tested.

**Switching Characteristics** Over the Operating Range<sup>[13]</sup>

| Parameter                            | Description                              | Condition <sup>[14]</sup>                                      | 74FCT16841AT        |      | 74FCT16841CT<br>74FCT162841CT |      | Unit | Fig. No. <sup>[15]</sup> |
|--------------------------------------|------------------------------------------|----------------------------------------------------------------|---------------------|------|-------------------------------|------|------|--------------------------|
|                                      |                                          |                                                                | Min.                | Max. | Min.                          | Max. |      |                          |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>D to Q<br>(LE=HIGH) | C <sub>L</sub> =50 pF<br>R <sub>L</sub> =500Ω                  | 1.5                 | 9.0  | 1.5                           | 5.5  | ns   | 1, 5                     |
|                                      |                                          | C <sub>L</sub> =300 pF <sup>[16]</sup><br>R <sub>L</sub> =500Ω | 1.5                 | 13.0 | 1.5                           | 13.0 |      |                          |
| t <sub>PLH</sub><br>t <sub>PHL</sub> | Propagation Delay<br>LE to Q             | C <sub>L</sub> =50 pF<br>R <sub>L</sub> =500Ω                  | 1.5                 | 12.0 | 1.5                           | 6.4  | ns   | 1, 5                     |
|                                      |                                          | C <sub>L</sub> =300 pF <sup>[16]</sup><br>R <sub>L</sub> =500Ω | 1.5                 | 16.0 | 1.5                           | 15.0 |      |                          |
| t <sub>PHZ</sub><br>t <sub>PZL</sub> | Output Enable Time<br>OE to Q            | C <sub>L</sub> =50 pF<br>R <sub>L</sub> =500Ω                  | 1.5                 | 11.5 | 1.5                           | 6.5  | ns   | 1, 7, 8                  |
|                                      |                                          | C <sub>L</sub> =300 pF <sup>[16]</sup><br>R <sub>L</sub> =500Ω | 1.5                 | 23.0 | 1.5                           | 12.0 |      |                          |
| t <sub>PHZ</sub><br>t <sub>PLZ</sub> | Output Disable Time<br>OE to Q           | C <sub>L</sub> =5 pF <sup>[16]</sup><br>R <sub>L</sub> =500Ω   | 1.5                 | 7.0  | 1.5                           | 5.7  | ns   | 1, 7, 8                  |
|                                      |                                          | C <sub>L</sub> =50 pF<br>R <sub>L</sub> =500Ω                  | 1.5                 | 8.0  | 1.5                           | 6.0  |      |                          |
| t <sub>SU</sub>                      | Set-Up Time<br>HIGH or LOW, D to LE      | C <sub>L</sub> =50 pF<br>R <sub>L</sub> =500Ω                  | 2.5                 | —    | 2.0                           | —    | ns   | 9                        |
| t <sub>H</sub>                       | Hold Time<br>HIGH or LOW, D to LE        |                                                                | 2.5                 | —    | 1.5                           | —    | ns   | 9                        |
| t <sub>W</sub>                       | LE Pulse Width HIGH                      |                                                                | 4.0 <sup>[17]</sup> | —    | 4.0 <sup>[17]</sup>           | —    | ns   | 5                        |
| t <sub>SK(O)</sub>                   | Output Skew <sup>[18]</sup>              |                                                                | —                   | 0.5  | —                             | 0.5  | ns   | —                        |

**Notes:**

13. Minimum limits are specified but not tested on Propagation Delays.
14. See test circuit and waveform.
15. See "Parameter Measurement Information" in the General Information section.
16. These conditions are specified but not tested.
17. These limits are specified but not tested.
18. Skew between any two outputs of the same package switching in the same direction. This parameter is ensured by design.

**Ordering Information for CY74FCT16841T**

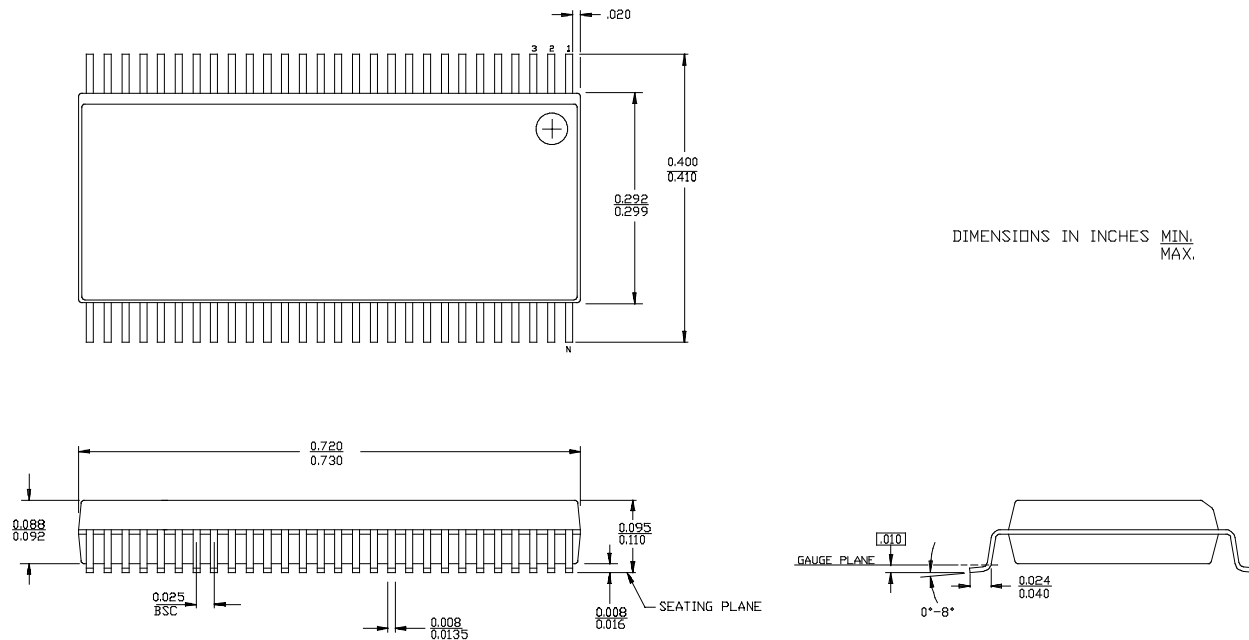
| Speed (ns) | Ordering Code          | Package Name | Package Type           | Operating Range |
|------------|------------------------|--------------|------------------------|-----------------|
| 5.5        | CY74FCT16841CTPVC/PVCT | O56          | 56-Lead (300-Mil) SSOP | Industrial      |
| 6.5        | CY74FCT16841ATPVC/PVCT | O56          | 56-Lead (300-Mil) SSOP |                 |

**Ordering Information CY74FCT162841T**

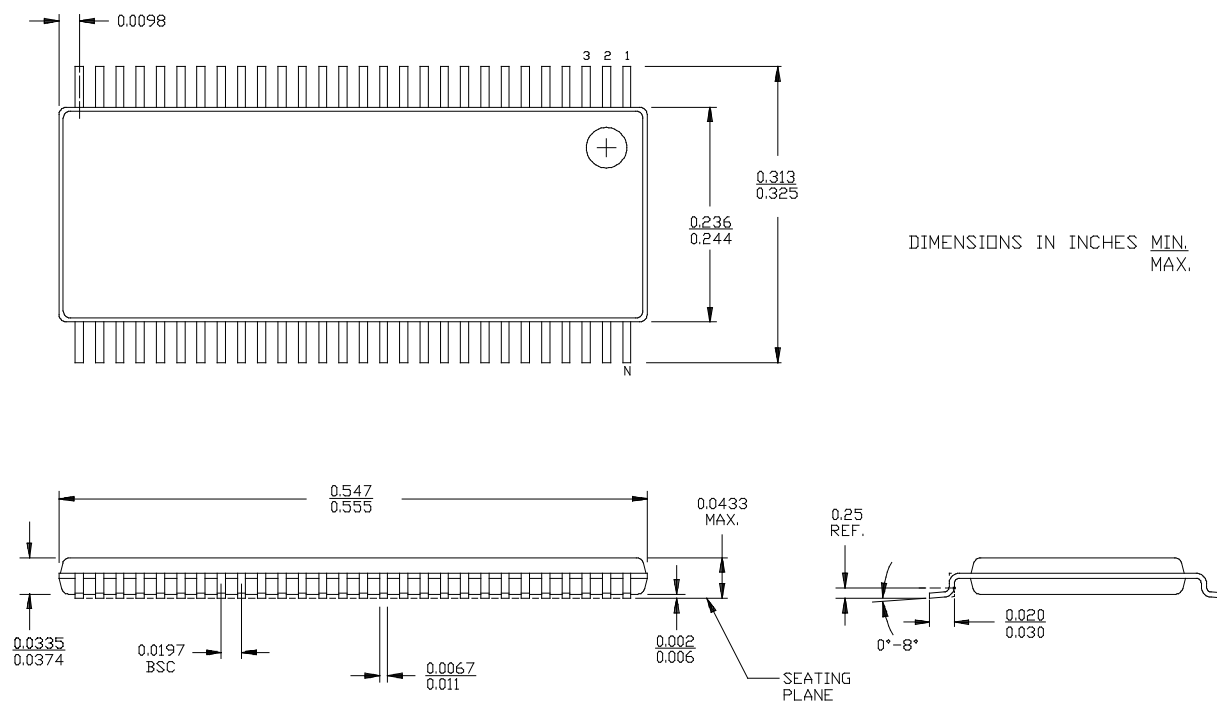
| Speed (ns) | Ordering Code      | Package Name | Package Type            | Operating Range |
|------------|--------------------|--------------|-------------------------|-----------------|
| 5.5        | 74FCT162841CTPACT  | Z56          | 56-Lead (240-Mil) TSSOP | Industrial      |
|            | CY74FCT162841CTPVC | O56          | 56-Lead (300-Mil) SSOP  |                 |
|            | 74FCT162841CTPVCT  | O56          | 56-Lead (300-Mil) SSOP  |                 |

**Package Diagrams**

**56-Lead Shrunk Small Outline Package O56**



**56-Lead Thin Shrunk Small Outline Package Z56**



## **IMPORTANT NOTICE**

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third-party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Mailing Address:

Texas Instruments  
Post Office Box 655303  
Dallas, Texas 75265